

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA1704

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

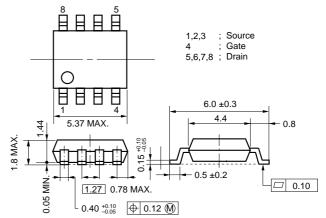
#### **DESCRIPTION**

This product is N-Channel MOS Field Effect Transistor designed for power management applications and Li-ion battery application.

#### **FEATURES**

- 2.5 V gate drive and low on-resistance
   R<sub>DS(on)1</sub> = 13 mΩ MAX. (V<sub>GS</sub> = 4.0 V, I<sub>D</sub> = 5.0 A)
   R<sub>DS(on)2</sub> = 16 mΩ MAX. (V<sub>GS</sub> = 2.5 V, I<sub>D</sub> = 5.0 A)
- Low Ciss : Ciss = 2700 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

## PACKAGE DRAWING (Unit : mm)



#### ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1704G	Power SOP8

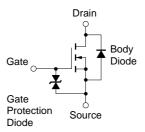
#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±12	V
Drain Current (DC)	ID(DC)	±10	Α
Drain Current (pulse) Note1	D(pulse)	±40	Α
Total Power Dissipation (T <sub>A</sub> = 25°C) Note2	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to + 150	°C

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

2. Mounted on ceramic substrate of 1200 mm<sup>2</sup> x 0.7mm

#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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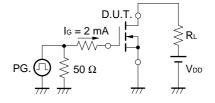
#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 4.0 V, ID = 5.0 A		9.8	13	mΩ
	RDS(on)2	Vgs = 2.5 V, ID = 5.0 A		12	16	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	0.5	0.8	1.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5.0 A	10	25		S
Drain Leakage Current	IDSS	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±12 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		2700		pF
Output Capacitance	Coss	Vgs = 0 V		880		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		400		pF
Turn-on Delay Time	td(on)	I <sub>D</sub> = 5.0 A		25		ns
Rise Time	tr	V <sub>GS(on)</sub> = 4.0 V		95		ns
Turn-off Delay Time	td(off)	V <sub>DD</sub> = 15 V		235		ns
Fall Time	t <sub>f</sub>	R <sub>G</sub> = 10 Ω		200		ns
Total Gate Charge	Q <sub>G</sub>	I <sub>D</sub> = 10 A		38		nC
Gate to Source Charge	Qgs	V <sub>DD</sub> = 24 V		3.3		nC
Gate to Drain Charge	Q <sub>GD</sub>	Vgs = 4.0 V		15		nC
Body Diode Forward Voltage	V <sub>F(S-D)</sub>	IF = 10 A, VGS = 0 V		0.8		V
Reverse Recovery Time	trr	IF = 10 A, VGS = 0 V		48		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		53		nC

#### **TEST CIRCUIT 1 SWITCHING TIME**

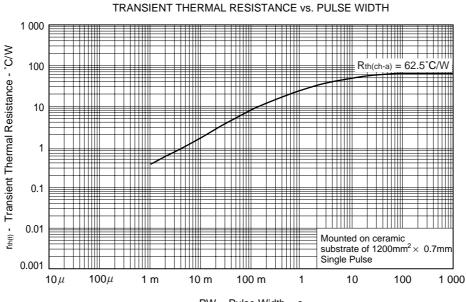
# PG. $\bigcap_{R_G} R_G = 10 \ \Omega$ $\tau = 1 \mu \text{ s}$ Duty Cycle $\leq 1 \%$

#### **TEST CIRCUIT 2 GATE CHARGE**

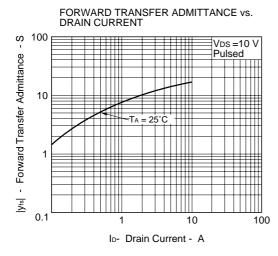


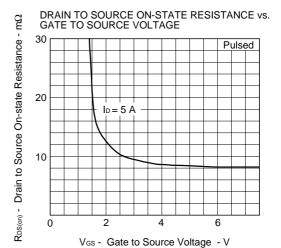


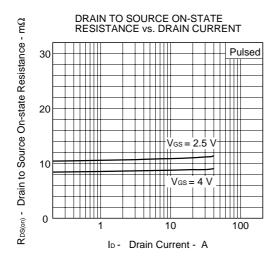
#### TYPICAL CHARACTERISTICS (TA = 25 °C)

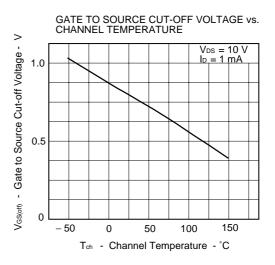




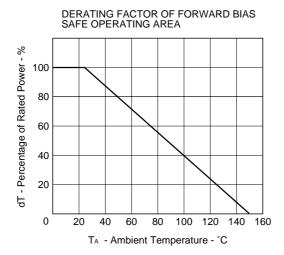


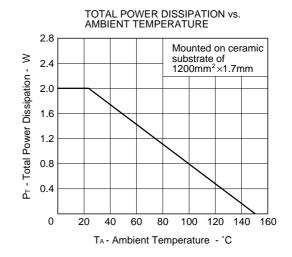






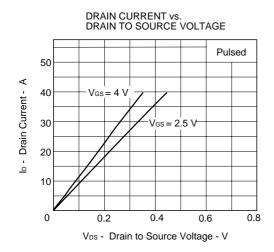
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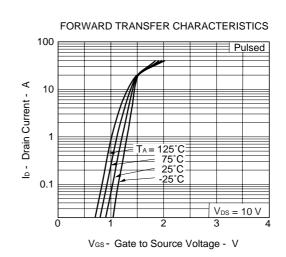


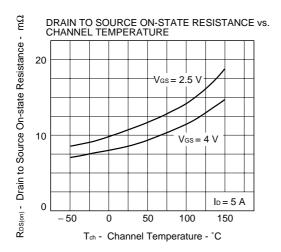


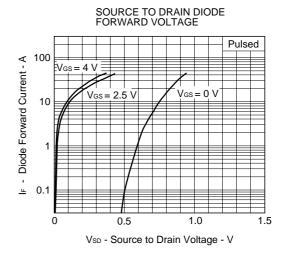
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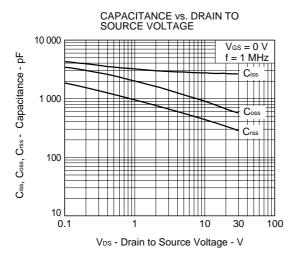
**Remark**Mounted on ceramic substrate of 1200mm<sup>2</sup> x 0.7mm

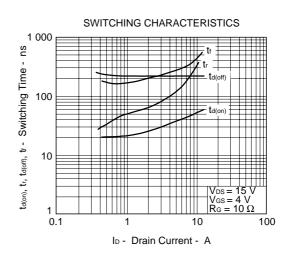


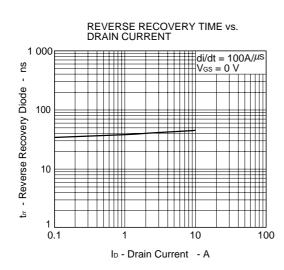


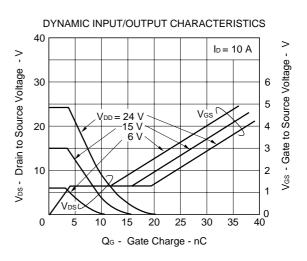












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